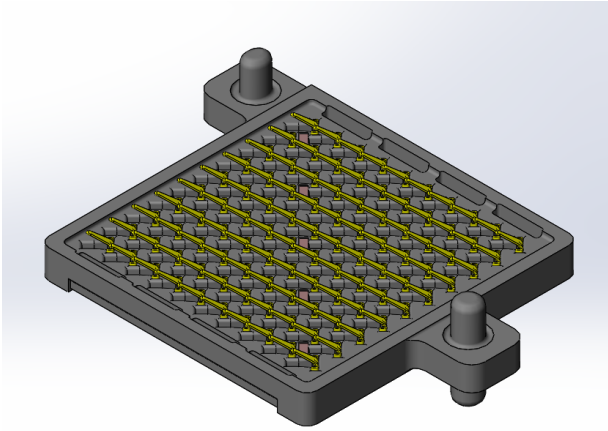
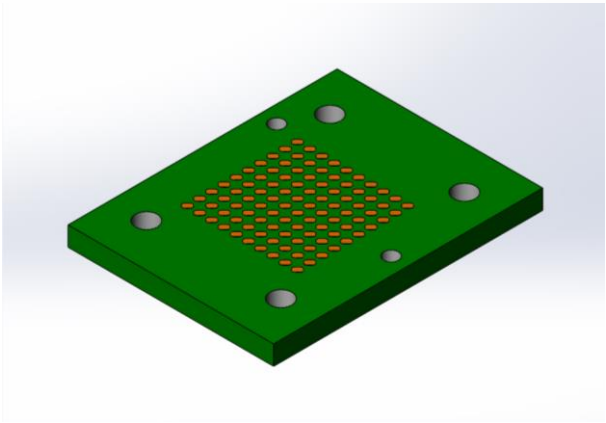
Project Number: Design Qualification Test Report	Tracking Code: 623651_Report_Rev_1
Requested by: Neal Patterson	Date: 12/7/2015
Part #: GMI-10-2-1.27-G-10/TOP&BOTTOM MATING BOARD	Tech: Aaron McKim
Part description: GMI/MATING BOARD	Qty to test: 80
Test Start: 10/15/2015	Test Completed: 11/19/2015





DESIGN QUALIFICATION TEST REPORT

GMI/MATING BOARD
GMI-10-2-1.27-G-10/TOP&BOTTOM MATING BOARD

REVISION HISTORY

DATA	REV.NUM.	DESCRIPTION	ENG
12/03/2015	**1**	**Initial Issue**	**PC**

CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to IS0 10012-l and ANSI/NCSL 2540-1, as applicable.

SCOPE

To perform the following tests: Design Qualification test. Please see test plan.

APPLICABLE DOCUMENTS

Standards: EIA Publication 364

TEST SAMPLES AND PREPARATION

1) All materials were manufactured in accordance with the applicable product specification.
2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
3) After soldering, the parts to be used for LLCR and DWV/IR testing were cleaned according to TLWI-0001.
4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
5) The automated procedure is used with aqueous compatible soldering materials.
6) Parts not intended for testing LLCR and DWV/IR are visually inspected and cleaned if necessary.
7) Any additional preparation will be noted in the individual test sequences.
8) Solder Information: Lead free
9) Samtec Test PCBs used: PCB-106924-TST-XX/ PCB-106925-TST-XX/ PCB-106443-TST-XX

FLOWCHARTS

Gas Tight

Group 1
GMI-10-2-1.27-G-10
GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
8 Assemblies

Step	Description
1.	LLCR (2)
2.	Gas Tight (1)
3.	LLCR (2) Max Delta = 15 mOhm

(1) Gas Tight = EIA-364-36

(2) LLCR = EIA-364-23
Open Circuit Voltage = 20 mV Max
Test Current = 100 mA Max

Normal Force

Group 1
GMI-10-2-1.27-G-10
GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
8 Contacts Minimum
Signal Without Thermals

Step	Description
1.	Contact Gaps
2.	Normal Force (1) Deflection = 0.012 " Expected Force at Max Deflection = 45 g

Group 2
GMI-10-2-1.27-G-10
GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
8 Contacts Minimum
Signal With Thermals

Step	Description
1.	Contact Gaps
2.	Thermal Age (2)
3.	Contact Gaps
4.	Normal Force (1) Deflection = 0.012 " Expected Force at Max Deflection = 45 g

(1) Normal Force = EIA-364-04

(2) Thermal Age = EIA-364-17
Test Condition = 4 (105°C)
Time Condition = B (250 Hours)

FLOWCHARTS Continued

Thermal Aging

Group 1

GMI-10-2-1.27-G-10

GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD

8 Assemblies

Step	Description
1.	Contact Gaps
2.	Mating/Unmating Force (2)
3.	LLCR (1)
4.	Thermal Age (3)
5.	LLCR (1) Max Delta = 15 mOhm
6.	Mating/Unmating Force (2)
7.	Contact Gaps

(1) LLCR = EIA-364-23
Open Circuit Voltage = 20 mV Max
Test Current = 100 mA Max

(2) Mating/Unmating Force = EIA-364-13

(3) Thermal Age = EIA-364-17
Test Condition = 4 (105°C)
Time Condition = B (250 Hours)

FLOWCHARTS Continued

Mating/Unmating/Durability

Group 1
GMI-10-2-1.27-G-10
GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
8 Assemblies

Step	Description
1.	Contact Gaps
2.	LLCR (2)
3.	Mating/Unmating Force (3)
4.	Cycles Quantity = 25 Cycles
5.	Mating/Unmating Force (3)
6.	Cycles Quantity = 25 Cycles
7.	Mating/Unmating Force (3)
8.	Cycles Quantity = 25 Cycles
9.	Mating/Unmating Force (3)
10.	Cycles Quantity = 25 Cycles
11.	Mating/Unmating Force (3)
12.	Contact Gaps
13.	LLCR (2) Max Delta = 15 mOhm
14.	Thermal Shock (4)
15.	LLCR (2) Max Delta = 15 mOhm
16.	Humidity (1)
17.	LLCR (2) Max Delta = 15 mOhm
18.	Mating/Unmating Force (3)

(1) Humidity = EIA-364-31
Test Condition = B (240 Hours)
Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)
Test Exceptions: ambient pre-condition and delete steps 7a ar

(2) LLCR = EIA-364-23
Open Circuit Voltage = 20 mV Max
Test Current = 100 mA Max

(3) Mating/Unmating Force = EIA-364-13

(4) Thermal Shock = EIA-364-32
Exposure Time at Temperature Extremes = 1/2 Hour
Method A, Test Condition = I (-55°C to +85°C)
Test Duration = A-3 (100 Cycles)

FLOWCHARTS Continued

IR/DWV

Pin-to-Pin

Group 1 GMI-10-2-1.27-G-10 GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD 2 Assemblies		Group 2 GMI-10-2-1.27-G-10 GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD 2 Assemblies	
Step	**Description**	**Step**	**Description**
1.	DWV Breakdown (2)	1.	IR (4)
		2.	DWV at Test Voltage (1)
		3.	Thermal Shock (5)
		4.	IR (4)
		5.	DWV at Test Voltage (1)
		6.	Humidity (3)
		7.	IR (4)
		8.	DWV at Test Voltage (1)

Row-to-Row

Group 3 GMI-10-2-1.27-G-10 GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD 2 Assemblies		Group 4 GMI-10-2-1.27-G-10 GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD 2 Assemblies	
Step	**Description**	**Step**	**Description**
1.	DWV Breakdown (2)	1.	IR (4)
		2.	DWV at Test Voltage (1)
		3.	Thermal Shock (5)
		4.	IR (4)
		5.	DWV at Test Voltage (1)
		6.	Humidity (3)
		7.	IR (4)
		8.	DWV at Test Voltage (1)

(1) DWV at Test Voltage = EIA-364-20
Test Condition = 1 (Sea Level)
DWV test voltage is equal to 75% of the lowest breakdown voltage
Test voltage applied for 60 seconds

(2) DWV Breakdown = EIA-364-20
Test Condition = 1 (Sea Level)
DWV test voltage is equal to 75% of the lowest breakdown voltage
Test voltage applied for 60 seconds

(3) Humidity = EIA-364-31
Test Condition = B (240 Hours)
Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)
Test Exceptions: ambient pre-condition and delete steps 7a and 7b

(4) IR = EIA-364-21
Test Condition = 500 Vdc, 2 Minutes Max

(5) Thermal Shock = EIA-364-32
Exposure Time at Temperature Extremes = 1/2 Hour
Method A, Test Condition = I (-55°C to +85°C)
Test Duration = A-3 (100 Cycles)

FLOWCHARTS Continued

Current Carrying Capacity

Group 1

GMI-10-2-1.27-G-10

GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
10 Pins Powered
Signal

Step	Description
1.	CCC (1) Rows = 10 Number of Positions = 1

Group 2

GMI-10-2-1.27-G-10

GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
20 Pins Powered
Signal

Step	Description
1.	CCC (1) Rows = 10 Number of Positions = 2

Group 3

GMI-10-2-1.27-G-10

GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
30 Pins Powered
Signal

Step	Description
1.	CCC (1) Rows = 10 Number of Positions = 3

Group 4

GMI-10-2-1.27-G-10

GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
40 Pins Powered
Signal

Step	Description
1.	CCC (1) Rows = 10 Number of Positions = 4

Group 5

GMI-10-2-1.27-G-10

GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
100 Pins Powered
Signal

Step	Description
1.	CCC (1) Rows = 10 Number of Positions = 10

(1) CCC = EIA-364-70
Method 2, Temperature Rise Versus Current Curve
(TIN PLATING) - Tabulate calculated current at RT, 65°C, 75°C and 95°C after derating 20% and based on 105°C
(GOLD PLATING) - Tabulate calculated current at RT, 85°C, 95°C and 115°C after derating 20% and based on 125°C

FLOWCHARTS Continued

Mechanical Shock/Random Vibration/LLCR

Group 1
GMI-10-2-1.27-G-10
GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
8 Assemblies

Step	Description
1.	LLCR (1)
2.	Mechanical Shock (2)
3.	Random Vibration (3)
4.	LLCR (1) Max Delta = 15 mOhm

(1) LLCR = EIA-364-23
Open Circuit Voltage = 20 mV Max
Test Current = 100 mA Max

(2) Mechanical Shock = EIA-364-27
Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)
Number of Shocks = 3 Per Direction, Per Axis, 18 Total

(3) Random Vibration = EIA-364-28
Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

Mechanical Shock/Random Vibration/Event Detection

Group 1
GMI-10-2-1.27-G-10
GMI-10-2-1.27-G-10 TOP & BOTTOM MATING BOARD
60 Points

Step	Description
1.	Nanosecond Event Detection (Mechanical Shock) (1)
2.	Nanosecond Event Detection (Random Vibration) (2)

(1) Nanosecond Event Detection (Mechanical Shock)
Use EIA-364-87 for Nanosecond Event Detection:
Test Condition = F (50 nanoseconds at 10 ohms)
Use EIA-364-27 for Mechanical Shock:
Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)
Number of Shocks = 3 Per Direction, Per Axis, 18 Total

(2) Nanosecond Event Detection (Random Vibration)
Use EIA-364-87 for Nanosecond Event Detection:
Test Condition = F (50 nanoseconds at 10 ohms)
Use EIA-364-28 for Random Vibration:
Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

THERMAL SHOCK:

1) EIA-364-32, *Thermal Shock (Temperature Cycling) Test Procedure for Electrical Connectors.*
2) Test Condition 1: -55℃ to +85℃
3) Test Time: ½ hour dwell at each temperature extreme
4) Number of Cycles: 100
5) All test samples are pre-conditioned at ambient.
6) All test samples are exposed to environmental stressing in the mated condition.

THERMAL:

1) EIA-364-17, *Temperature Life with or without Electrical Load Test Procedure for Electrical Connectors.*
2) Test Condition 4 at 105° C
3) Test Time Condition B for 250 hours.
4) All test samples are pre-conditioned at ambient.
5) All test samples are exposed to environmental stressing in the mated condition.

HUMIDITY:

1) Reference document: EIA-364-31, *Humidity Test Procedure for Electrical Connectors.*
2) Test Condition B, 240 Hours.
3) Method III, +25° C to + 65° C, 90% to 98% Relative Humidity excluding sub-cycles 7a and 7b.
4) All samples are pre-conditioned at ambient.
5) All test samples are exposed to environmental stressing in the mated condition.

MECHANICAL SHOCK (Specified Pulse):

1) Reference document: EIA-364-27, *Mechanical Shock Test Procedure for Electrical Connectors*
2) Test Condition C
3) Peak Value: 100 G
4) Duration: 6 Milliseconds
5) Wave Form: Half Sine
6) Velocity: 12.3 ft/s
7) Number of Shocks: 3 Shocks / Direction, 3 Axis (18 Total)

VIBRATION:

1) Reference document: EIA-364-28, *Vibration Test Procedure for Electrical Connectors*
2) Test Condition V, Letter B
3) Power Spectral Density: 0.04 G^2 / Hz
4) G 'RMS': 7.56
5) Frequency: 50 to 2000 Hz
6) Duration: 2.0 Hours per axis (3 axis total)

NANOSECOND-EVENT DETECTION:

1) Reference document: EIA-364-87, *Nanosecond-Event Detection for Electrical Connectors*
2) Prior to test, the samples were characterized to assure the low nanosecond event being monitored will trigger the detector.
3) After characterization it was determined the test samples could be monitored for 50 nanosecond events

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

MATING/UNMATING:

1) Reference document: EIA-364-13, *Mating and Unmating Forces Test Procedure for Electrical Connectors*.
2) The full insertion position was to within 0.003" to 0.004" of the plug bottoming out in the receptacle to prevent damage to the system under test.
3) One of the mating parts is secured to a floating X-Y table to prevent damage during cycling.

TEMPERATURE RISE (Current Carrying Capacity, CCC):

1) EIA-364-70, *Temperature Rise versus Current Test Procedure for Electrical Connectors and Sockets*.
2) When current passes through a contact, the temperature of the contact increases as a result of I^2R (resistive) heating.
3) The number of contacts being investigated plays a significant part in power dissipation and therefore temperature rise.
4) The size of the temperature probe can affect the measured temperature.
5) Copper traces on PC boards will contribute to temperature rise:
    a. Self heating (resistive)
    b. Reduction in heat sink capacity affecting the heated contacts
6) A de-rating curve, usually 20%, is calculated.
7) Calculated de-rated currents at four temperature points are reported:
    a. Ambient
    b. 85^{o} C
    c. 95^{o} C
    d. 115^{o} C
8) Typically, neighboring contacts (in close proximity to maximize heat build up) are energized.
9) The thermocouple (or temperature measuring probe) will be positioned at a location to sense the maximum temperature in the vicinity of the heat generation area.
10) A computer program, *TR 803.exe*, ensures accurate stability for data acquisition.
11) Hook-up wire cross section is larger than the cross section of any connector leads/PC board traces, jumpers, etc.
12) Hook-up wire length is longer than the minimum specified in the referencing standard.

LLCR:

1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
    a. <= +5.0 mOhms:---------- Stable
    b. +5.1 to +10.0 mOhms:---------- Minor
    c. +10.1 to +15.0 mOhms: ---------- Acceptable
    d. +15.1 to +50.0 mOhms: ---------- Marginal
    e. +50.1 to +2000 mOhms: ---------- Unstable
    f. >+2000 mOhms:---------- Open Failure

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

GAS TIGHT:

To provide method for evaluating the ability of the contacting surfaces in preventing penetration of harsh vapors which might lead to oxide formation that may degrade the electrical performance of the contact system.

1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
    a. <= +5.0 mOhms:---------- Stable
    b. +5.1 to +10.0 mOhms:---------- Minor
    c. +10.1 to +15.0 mOhms: ---------- Acceptable
    d. +15.1 to +50.0 mOhms: ---------- Marginal
    e. +50.1 to +2000 mOhms: ---------- Unstable
    f. >+2000 mOhms:---------- Open Failure
4) Procedure:
    a. Reference document: EIA-364-36, *Test Procedure for Determination of Gas-Tight Characteristics for Electrical Connectors, Sockets and/or Contact Systems*.
    b. Test Conditions:
        i. Class II--- Mated pairs of contacts assembled to their plastic housings.
        ii. Reagent grade Nitric Acid shall be used of sufficient volume to saturate the test chamber
        iii. The ratio of the volume of the test chamber to the surface area of the acid shall be 10:1.
        iv. The chamber shall be saturated with the vapor for at least 15 minutes before samples are added.
        v. Exposure time, 55 to 65 minutes.
        vi. The samples shall be no closer to the chamber walls than 1 inches and no closer to the surface of the acid than 3 inches.
        vii. The samples shall be dried after exposure for a minimum of 1 hour.
        viii. Drying temperature 50^{o} C
        ix. The final LLCR shall be conducted within 1 hour after drying.

NORMAL FORCE (FOR CONTACTS TESTED IN THE HOUSING):

1) Reference document: EIA-364-04, *Normal Force Test Procedure for Electrical Connectors*.
2) The contacts shall be tested in the connector housing.
3) If necessary, a "window" shall be made in the connector body to allow a probe to engage and deflect the contact at the same attitude and distance (plus 0.05 mm [0.002"]) as would occur in actual use.
4) The connector housing shall be placed in a holding fixture that does not interfere with or otherwise influence the contact force or deflection.
5) Said holding fixture shall be mounted on a floating, adjustable, X-Y table on the base of the Dillon TC^2, computer controlled test stand with a deflection measurement system accuracy of 5.0 µm (0.0002").
6) The nominal deflection rate shall be 5 mm (0.2")/minute.
7) Unless otherwise noted a minimum of five contacts shall be tested.
8) The force/deflection characteristic to load and unload each contact shall be repeated five times.
9) The system shall utilize the TC^2 software in order to acquire and record the test data.
10) The permanent set of each contact shall be measured within the TC^2 software.
11) The acquired data shall be graphed with the deflection data on the X-axis and the force data on the Y-axis and a print out will be stored with the Tracking Code paperwork.

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes

INSULATION RESISTANCE (IR):

To determine the resistance of insulation materials to leakage of current through or on the surface of these materials when a DC potential is applied.

1) PROCEDURE:
    a. Reference document: EIA-364-21, *Insulation Resistance Test Procedure for Electrical Connectors*.
    b. Test Conditions:
        i. Between Adjacent Contacts or Signal-to-Ground
        ii. Electrification Time 2.0 minutes
        iii. Test Voltage (500 VDC) corresponds to calibration settings for measuring resistances.
2) MEASUREMENTS:
3) When the specified test voltage is applied (VDC), the insulation resistance shall not be less than 5000 megohms.

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

To determine if the sockets can operate at its rated voltage and withstand momentary over potentials due to switching, surges, and other similar phenomenon. Separate samples are used to evaluate the effect of environmental stresses so not to influence the readings from arcing that occurs during the measurement process.

1) PROCEDURE:
    a. Reference document: EIA-364-20, *Withstanding Voltage Test Procedure for Electrical Connectors*.
    b. Test Conditions:
        i. Between Adjacent Contacts or Signal-to-Ground
        ii. Barometric Test Condition 1
        iii. Rate of Application 500 V/Sec
        iv. Test Voltage (VAC) until breakdown occurs
2) MEASUREMENTS/CALCULATIONS
    a. The breakdown voltage shall be measured and recorded.
    b. The dielectric withstanding voltage shall be recorded as 75% of the minimum breakdown voltage.
    c. The working voltage shall be recorded as one-third (1/3) of the dielectric withstanding voltage (one-fourth of the breakdown voltage).

RESULTS

Temperature Rise, CCC at a 20% de-rating

- **CCC for a 30°C Temperature Rise----------0.89 A per contact with 10 contacts (10x1) powered**
- **CCC for a 30°C Temperature Rise----------0.64 A per contact with 20 contacts (10x2) powered**
- **CCC for a 30°C Temperature Rise----------0.56 A per contact with 30 contacts (10x3) powered**
- **CCC for a 30°C Temperature Rise----------0.46 A per contact with 40 contacts (10x4) powered**
- **CCC for a 30°C Temperature Rise----------0.33 A per contact with All contacts (10x10) powered**

Mating – Unmating Forces

Thermal Aging Group

- **Initial**
  - **Mating**
    - **Min ---------- 8.02 Lbs**
    - **Max---------- 9.50 Lbs**
- **After Thermal**
  - **Mating**
    - **Min ---------- 6.04 Lbs**
    - **Max---------- 7.28 Lbs**

Mating-Unmating Durability Group

- **Initial**
  - **Mating**
    - **Min ---------- 6.14 Lbs**
    - **Max---------- 7.56 Lbs**
- **After 25 Cycles**
  - **Mating**
    - **Min ---------- 5.55 Lbs**
    - **Max---------- 6.95 Lbs**
- **After 50 Cycles**
  - **Mating**
    - **Min ---------- 5.46 Lbs**
    - **Max---------- 6.40 Lbs**
- **After 75 Cycles**
  - **Mating**
    - **Min ---------- 5.56 Lbs**
    - **Max---------- 6.33 Lbs**
- **After 100 Cycles**
  - **Mating**
    - **Min ---------- 5.23 Lbs**
    - **Max---------- 6.78 Lbs**
- **Humidity**
  - **Mating**
    - **Min ---------- 4.60 Lbs**
    - **Max---------- 5.79 Lbs**

Normal Force at .0120 inch deflection

- **Initial**
  - **Min----------42.40 gf Set ----- 0.0026 in**
  - **Max ----------51.70 gf Set ----- 0.0036 in**
- **Thermal**
  - **Min----------13.90 gf Set----- 0.0057 in**
  - **Max ----------29.40 gf Set----- 0.0086 in**

RESULTS Continued

Insulation Resistance minimums, IR

Pin to Pin

- **Initial**
  - **Mated----------45000 Meg Ω ---------- Passed**
  - **Unmated ----------45000 Meg Ω ---------- Passed**
- **Thermal Shock**
  - **Mated----------45000 Meg Ω ---------- Passed**
  - **Unmated ----------45000 Meg Ω ---------- Passed**
- **Humidity**
  - **Mated----------45000 Meg Ω ---------- Passed**
  - **Unmated ----------45000 Meg Ω ---------- Passed**

Row to Row

- **Initial**
  - **Mated----------45000 Meg Ω ---------- Passed**
  - **Unmated ----------45000 Meg Ω ---------- Passed**
- **Thermal Shock**
  - **Mated----------45000 Meg Ω ---------- Passed**
  - **Unmated ----------45000 Meg Ω ---------- Passed**
- **Humidity**
  - **Mated----------45000 Meg Ω ---------- Passed**
  - **Unmated ----------45000 Meg Ω ---------- Passed**

Dielectric Withstanding Voltage minimums, DWV

- **Minimums**
  - **Breakdown Voltage----------800 VAC**
  - **Test Voltage ----------600 VAC**
  - **Working Voltage ----------200 VAC**

Pin to Pin

- **Initial DWV ----------Passed**
- **Thermal DWV----------Passed**
- **Humidity DWV----------Passed**

Row to Row

- **Initial DWV ----------Passed**
- **Thermal DWV----------Passed**
- **Humidity DWV----------Passed**

RESULTS Continued

LLCR Thermal Aging Group (192 LLCR test points)

- **Initial ---------- 35.16 mOhms Max**
- **Thermal**
  - **<= +5.0 mOhms ---------- 189 Points ---------- Stable**
  - **+5.1 to +10.0 mOhms ----------3 Points ---------- Minor**
  - **+10.1 to +15.0 mOhms ----------0 Points ---------- Acceptable**
  - **+15.1 to +50.0 mOhms ----------0 Points ---------- Marginal**
  - **+50.1 to +2000 mOhms----------0 Points ---------- Unstable**
  - **>+2000 mOhms----------0 Points ---------- Open Failure**

LLCR Mating/Unmating Durability Group (192 LLCR test points)

Initial ----------24.73 mOhms Max

- **Durability, 100 Cycles**
  - **<= +5.0 mOhms ---------- 189 Points ---------- Stable**
  - **+5.1 to +10.0 mOhms ----------3 Points ---------- Minor**
  - **+10.1 to +15.0 mOhms ----------0 Points ---------- Acceptable**
  - **+15.1 to +50.0 mOhms ----------0 Points ---------- Marginal**
  - **+50.1 to +2000 mOhms----------0 Points ---------- Unstable**
  - **>+2000 mOhms----------0 Points ---------- Open Failure**
- **Thermal Shock**
  - **<= +5.0 mOhms ---------- 186 Points ---------- Stable**
  - **+5.1 to +10.0 mOhms ----------6 Points ---------- Minor**
  - **+10.1 to +15.0 mOhms ----------0 Points ---------- Acceptable**
  - **+15.1 to +50.0 mOhms ----------0 Points ---------- Marginal**
  - **+50.1 to +2000 mOhms----------0 Points ---------- Unstable**
  - **>+2000 mOhms----------0 Points ---------- Open Failure**
- **Humidity**
  - **<= +5.0 mOhms ---------- 186 Points ---------- Stable**
  - **+5.1 to +10.0 mOhms ----------5 Points ---------- Minor**
  - **+10.1 to +15.0 mOhms ----------1 Points ---------- Acceptable**
  - **+15.1 to +50.0 mOhms ----------0 Points ---------- Marginal**
  - **+50.1 to +2000 mOhms----------0 Points ---------- Unstable**
  - **>+2000 mOhms----------0 Points ---------- Open Failure**

LLCR Gas Tight Group (192 LLCR test points)

- **Initial ---------- 24.76 mOhms Max**
- **Gas-Tight**
  - **<= +5.0 mOhms ---------- 192 Points ---------- Stable**
  - **+5.1 to +10.0 mOhms ----------0 Points ---------- Minor**
  - **+10.1 to +15.0 mOhms ----------0 Points ---------- Acceptable**
  - **+15.1 to +50.0 mOhms ----------0 Points ---------- Marginal**
  - **+50.1 to +2000 mOhms----------0 Points ---------- Unstable**
  - **>+2000 mOhms----------0 Points ---------- Open Failure**

RESULTS Continued

LLCR Shock & Vibration Group (192 LLCR test points)

- **Initial ---------- 33.67 mOhms Max**
- **Shock &Vibration**
  - **<= +5.0 mOhms ---------- 191 Points ---------- Stable**
  - **+5.1 to +10.0 mOhms ----------1 Points ---------- Minor**
  - **+10.1 to +15.0 mOhms ----------0 Points ---------- Acceptable**
  - **+15.1 to +50.0 mOhms ----------0 Points ---------- Marginal**
  - **+50.1 to +2000 mOhms----------0 Points ---------- Unstable**
  - **>+2000 mOhms----------0 Points ---------- Open Failure**

Mechanical Shock & Random Vibration:

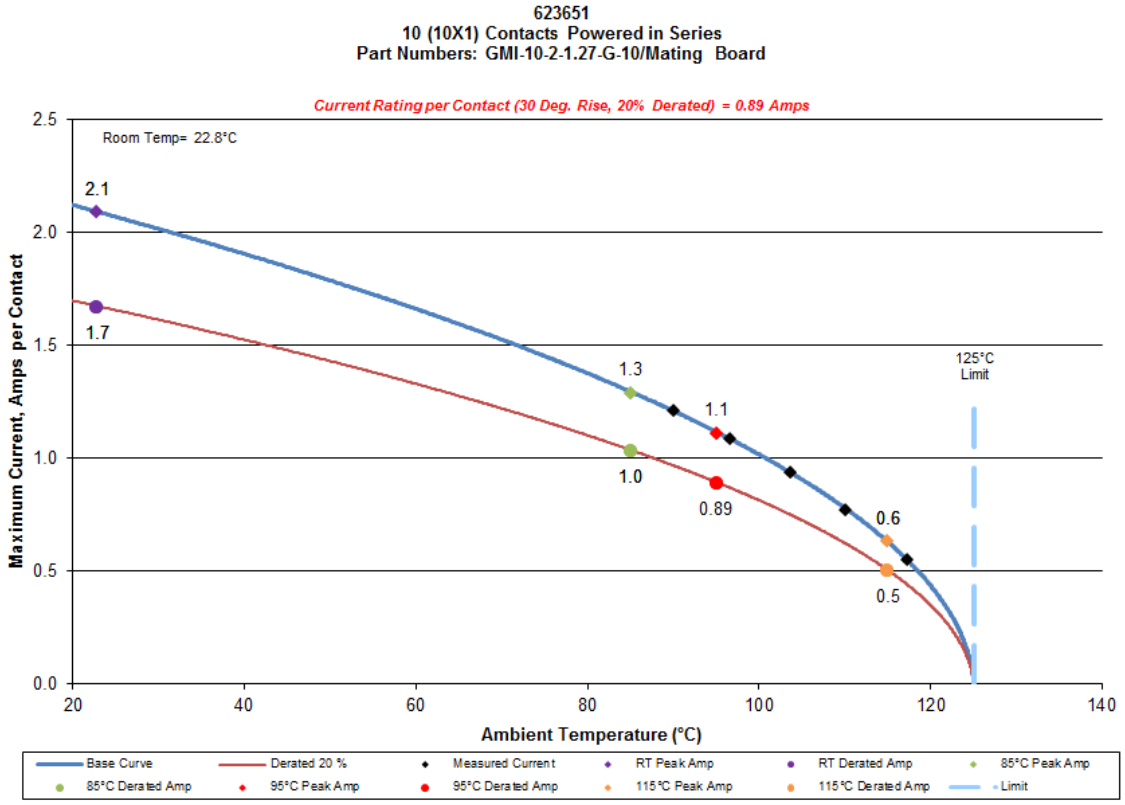
- **Shock**
  - **No Damage---------- ---------- Pass**
  - **50 Nanoseconds---------- ---------- Pass**
- **Vibration**
  - **No Damage---------- ---------- Pass**
  - **50 Nanoseconds---------- ---------- Pass**

DATA SUMMARIES

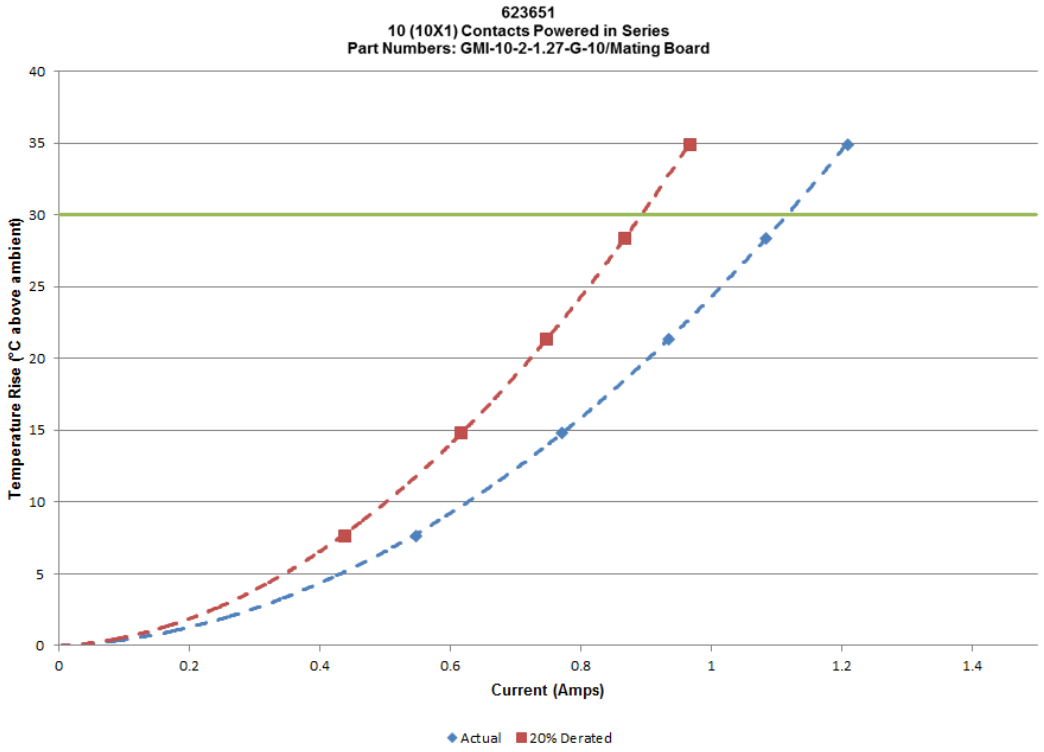
TEMPERATURE RISE (Current Carrying Capacity, CCC):

1) High quality thermocouples whose temperature slopes track one another were used for temperature monitoring.
2) The thermocouples were placed at a location to sense the maximum temperature generated during testing.
3) Temperature readings recorded are those for which three successive readings, 15 minutes apart, differ less than 1° C (computer controlled data acquisition).
4) Adjacent contacts were powered:

a. Linear configuration with 10 adjacent conductors/contacts powered

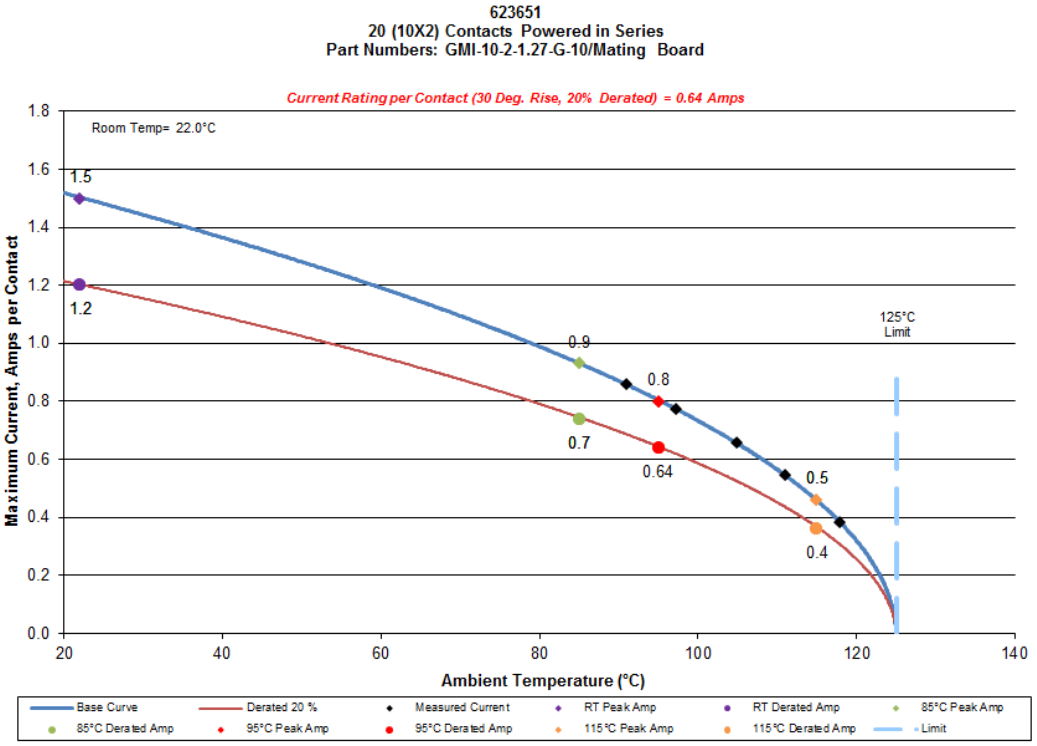


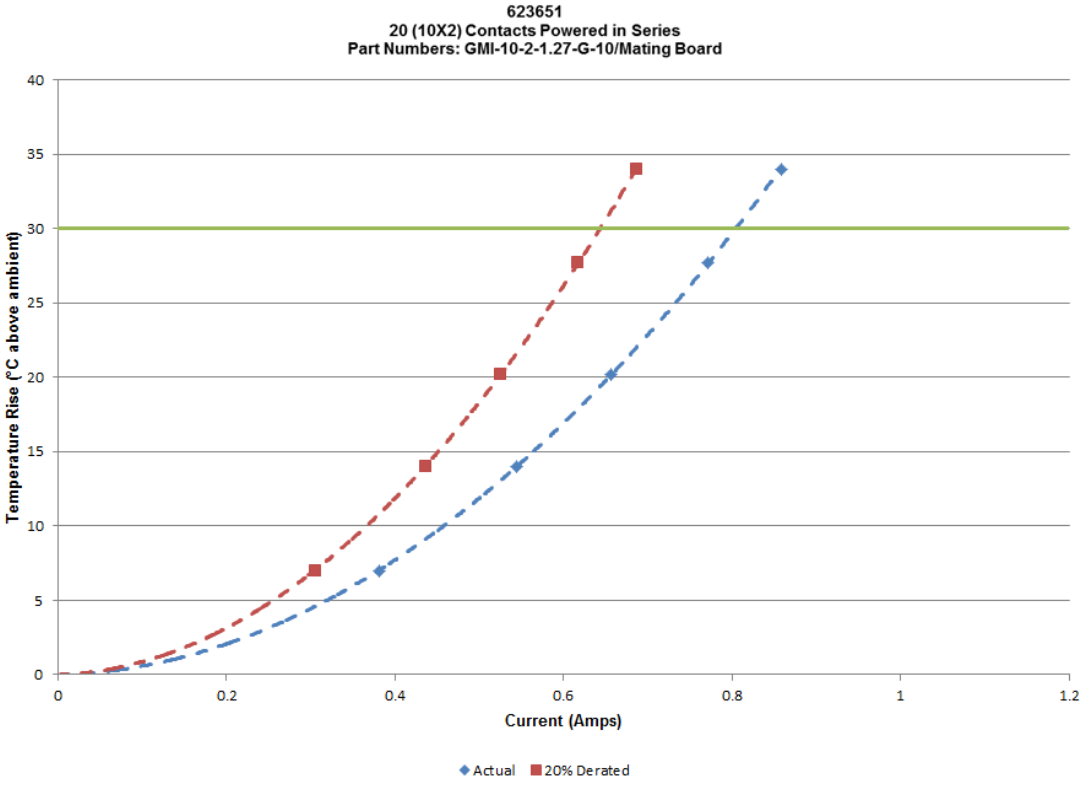
DATA SUMMARIES Continued



DATA SUMMARIES Continued

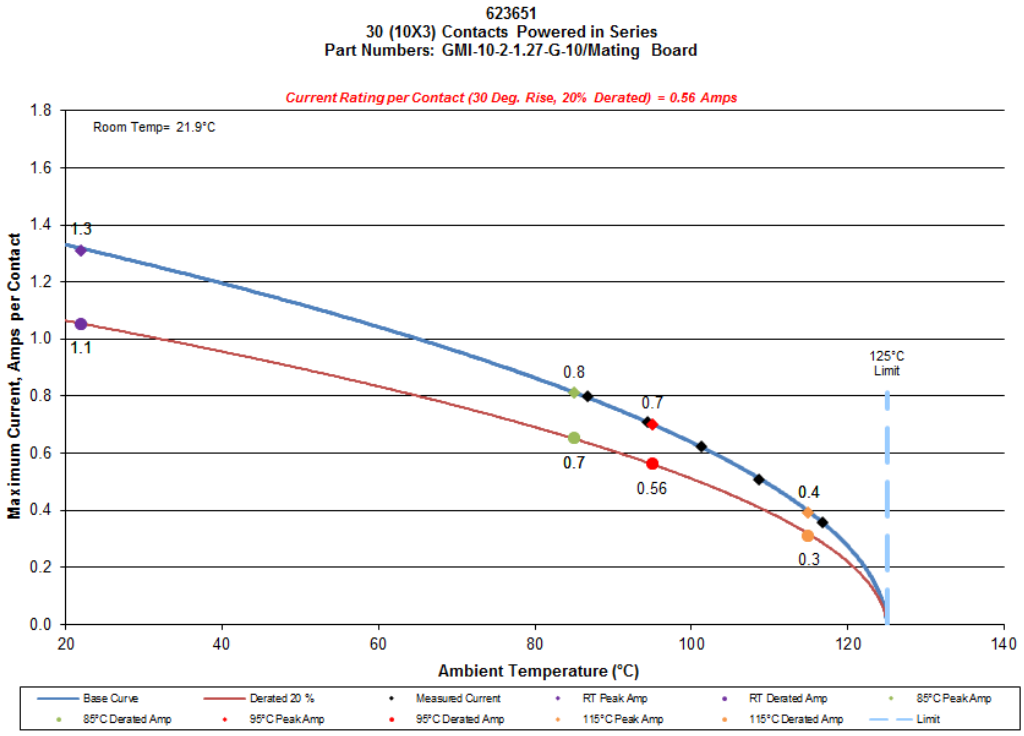
b. Linear configuration with 20 adjacent conductors/contacts powered

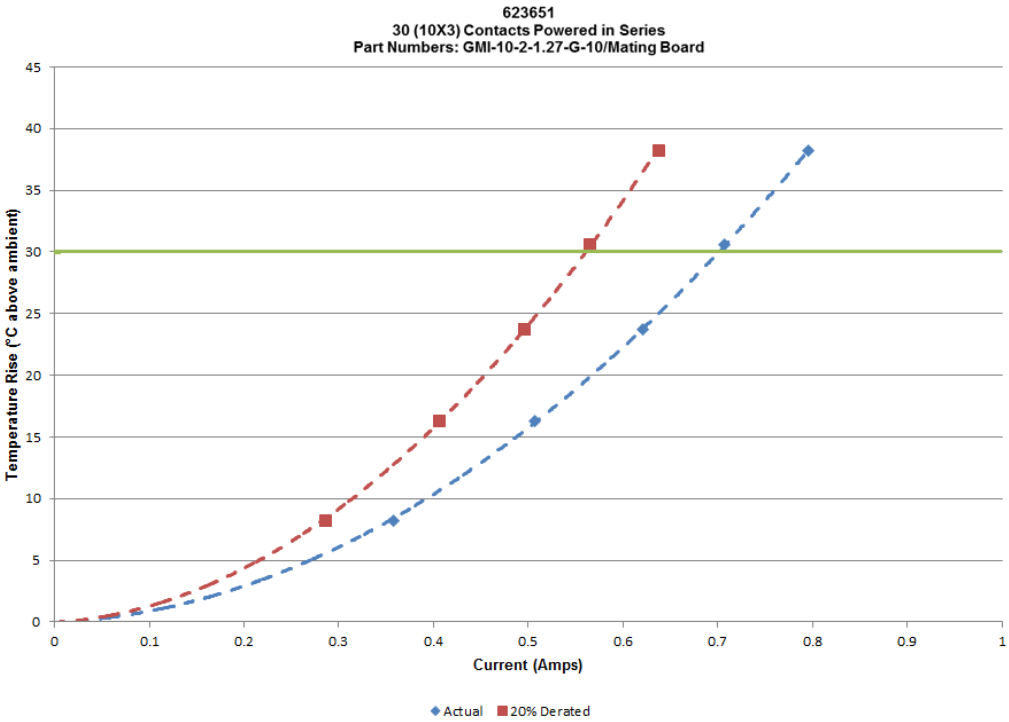




DATA SUMMARIES Continued

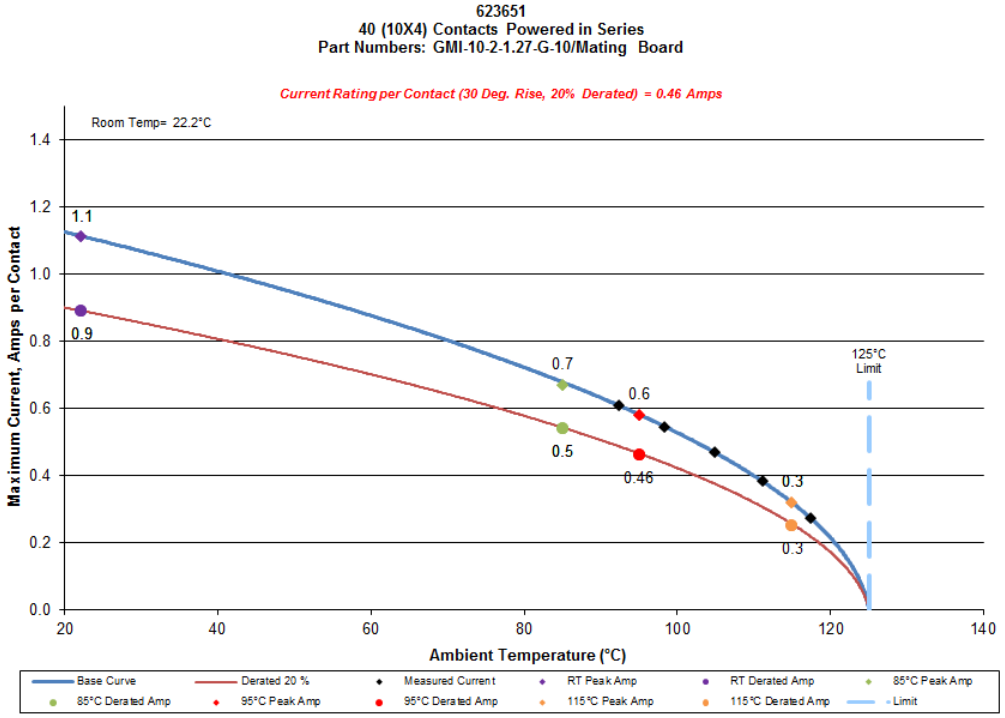
c. Linear configuration with 30 adjacent conductors/contacts powered

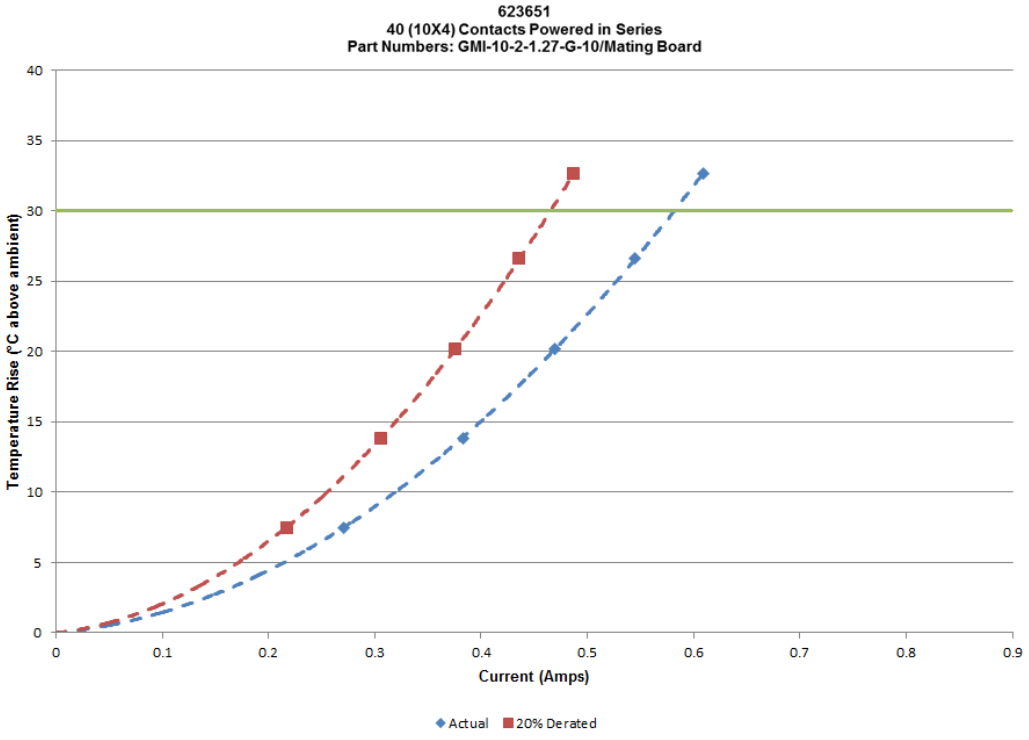




DATA SUMMARIES Continued

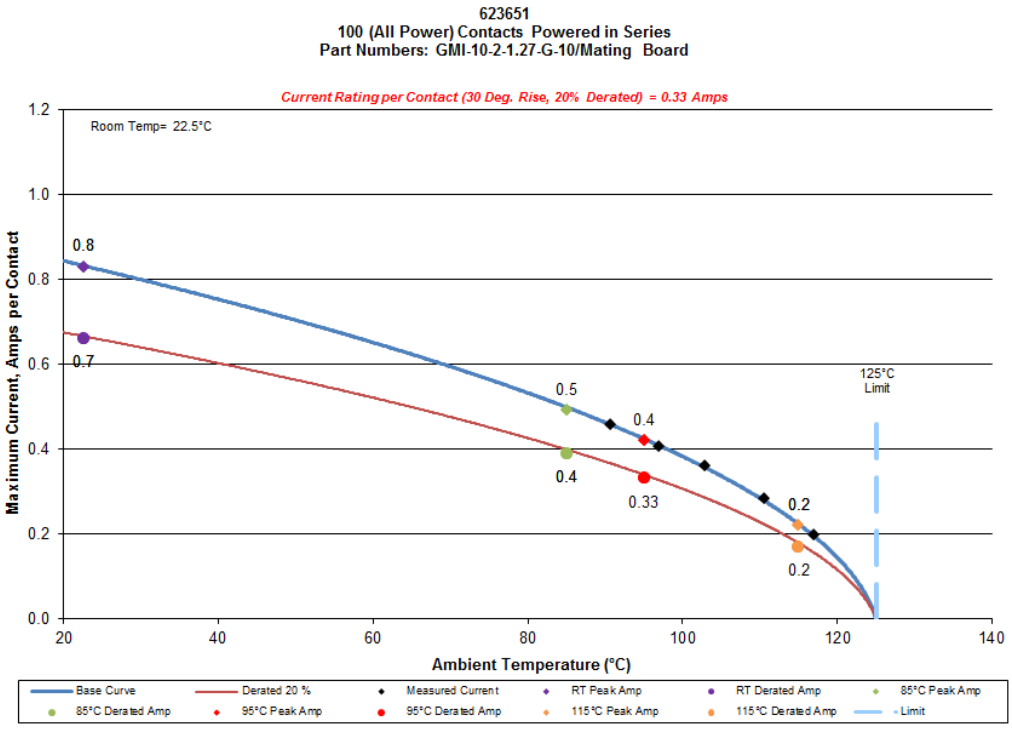
d. Linear configuration with 40 adjacent conductors/contacts powered

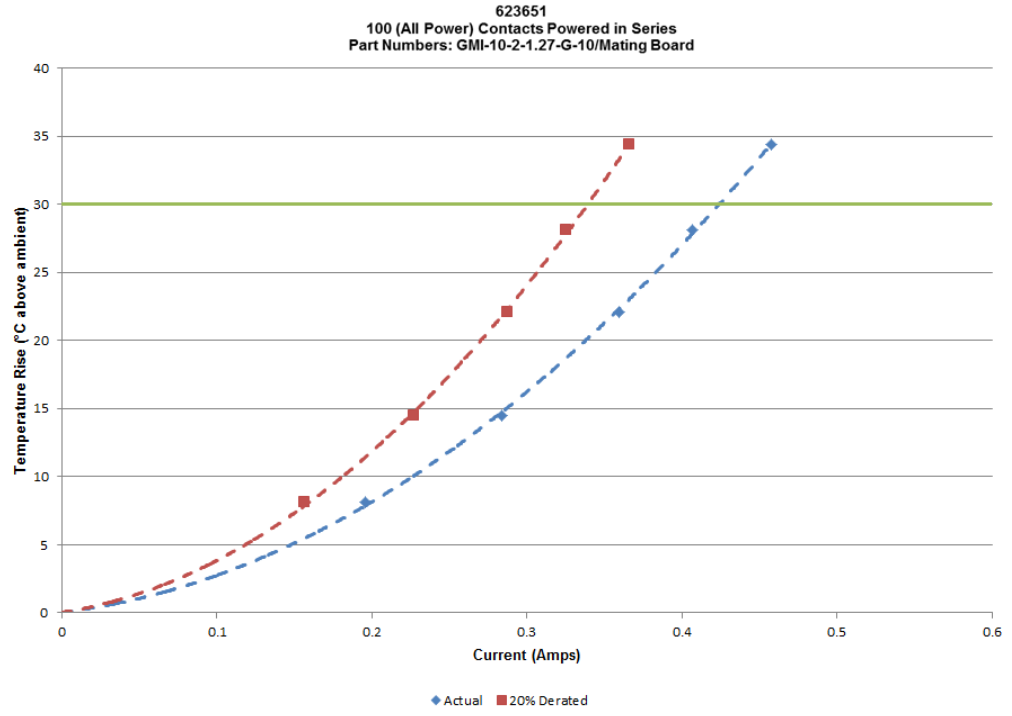




DATA SUMMARIES Continued

e. Linear configuration with all adjacent conductors/contacts powered





DATA SUMMARIES Continued

MATING-UNMATING FORCE:

Thermal Aging Group

	Initial				After Thermals			
	Mating		**Unmating**		**Mating**		**Unmating**	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	35.68	8.02	0.00	0.00	26.86	6.04	0.00	0.00
Maximum	42.26	9.50	0.00	0.00	32.40	7.28	0.00	0.00
Average	39.62	**8.91**	0.00	**0.00**	29.30	**6.59**	0.00	**0.00**
St Dev	1.97	0.44	0.00	0.00	2.00	0.45	0.00	0.00
Count	8	8	8	8	8	8	8	8

Mating-Unmating Durability Gaps Group

	Initial				After 25 Cycles			
	Mating		**Unmating**		**Mating**		**Unmating**	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	27.32	6.14	0.00	0.00	24.68	5.55	0.00	0.00
Maximum	34.01	7.65	0.00	0.00	30.91	6.95	0.00	0.00
Average	30.01	**6.75**	0.00	**0.00**	28.14	**6.33**	0.00	**0.00**
St Dev	2.25	0.51	0.00	0.00	1.98	0.45	0.00	0.00
Count	8	8	8	8	8	8	8	8
	After 50 Cycles				After 75 Cycles			
	Mating		**Unmating**		**Mating**		**Unmating**	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	24.29	5.46	0.00	0.00	24.72	5.56	0.00	0.00
Maximum	28.46	6.40	0.00	0.00	28.15	6.33	0.00	0.00
Average	26.19	**5.89**	0.00	**0.00**	26.69	**6.00**	0.00	**0.00**
St Dev	1.50	0.34	0.00	0.00	1.25	0.28	0.00	0.00
Count	8	8	8	8	8	8	8	8
	After 100 Cycles				After Humidity			
	Mating		**Unmating**		**Mating**		**Unmating**	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	23.26	5.23	0.00	0.00	20.45	4.60	0.00	0.00
Maximum	30.16	6.78	0.00	0.00	25.75	5.79	0.00	0.00
Average	26.76	**6.02**	0.00	**0.00**	24.01	**5.40**	0.00	**0.00**
St Dev	2.18	0.49	0.00	0.00	1.66	0.37	0.00	0.00
Count	8	8	8	8	8	8	8	8

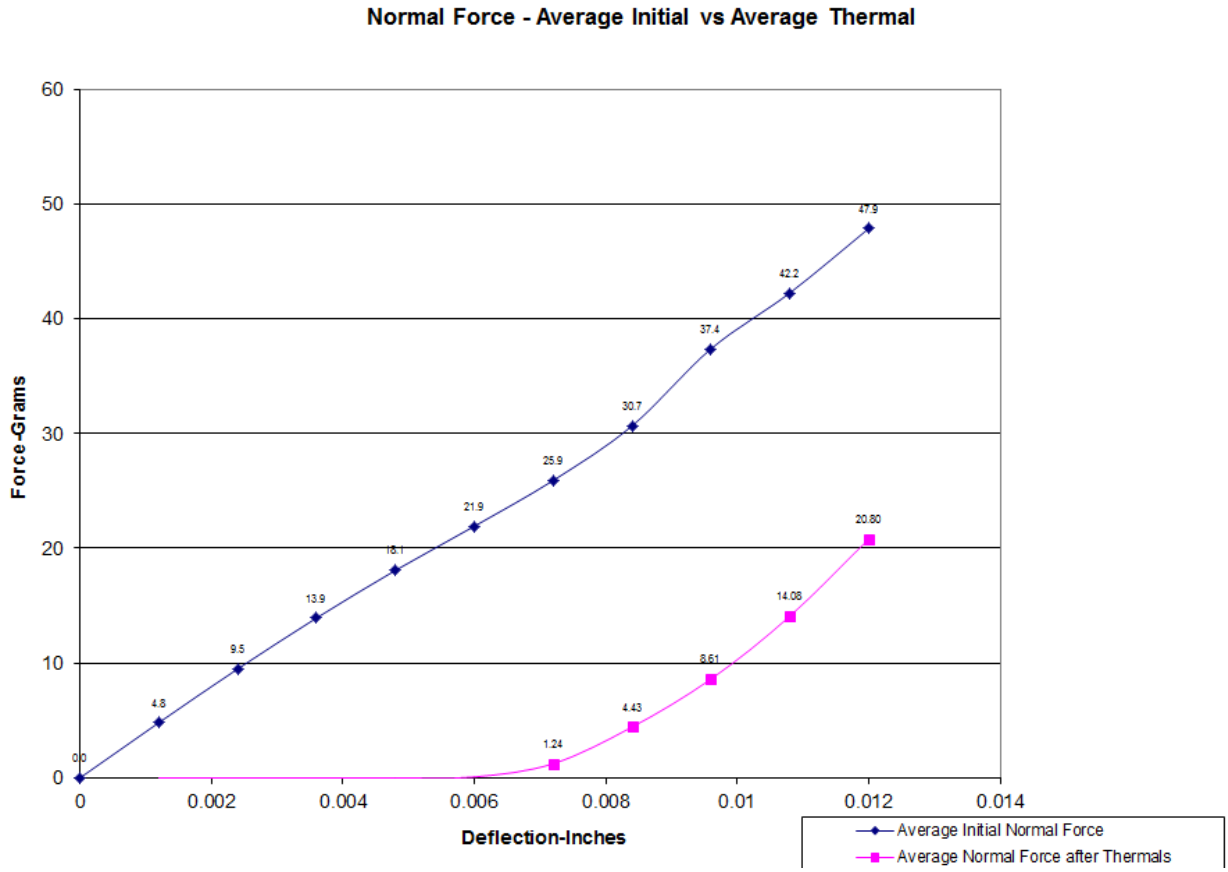
DATA SUMMARIES Continued

NORMAL FORCE (FOR CONTACTS TESTED IN THE HOUSING):

1) Calibrated force gauges are used along with computer controlled positioning equipment.
2) For Normal force 8-10 measurements are taken and the averages reported.

Initial	Deflections in inches Forces in Grams										
	0.0012	**0.0024**	**0.0036**	**0.0048**	**0.0060**	**0.0072**	**0.0084**	**0.0096**	**0.0108**	**0.0120**	***SET***
Averages	**4.81**	**9.49**	**13.93**	**18.08**	**21.93**	**25.91**	**30.67**	**37.37**	**42.24**	**47.85**	**0.0033**
Min	4.50	8.90	13.20	17.50	21.30	24.70	28.70	34.50	37.40	42.40	0.0026
Max	5.10	9.90	14.50	18.60	22.80	29.80	35.40	44.50	48.90	51.70	0.0036
St. Dev	0.178	0.287	0.377	0.386	0.501	1.376	1.917	2.670	3.053	2.586	0.0003
Count	12	12	12	12	12	12	12	12	12	12	12

After Thermals	Deflections in inches Forces in Grams										
	0.0012	**0.0024**	**0.0036**	**0.0048**	**0.0060**	**0.0072**	**0.0084**	**0.0096**	**0.0108**	**0.0120**	***SET***
Averages	**0.00**	**0.00**	**0.00**	**0.00**	**0.08**	**1.24**	**4.43**	**8.61**	**14.08**	**20.80**	**0.0071**
Min	0.00	0.00	0.00	0.00	0.00	-0.20	-0.10	3.10	6.60	13.90	0.0057
Max	0.00	0.00	0.00	0.00	1.00	5.20	9.30	15.30	21.70	29.40	0.0086
St. Dev	0.000	0.000	0.000	0.000	0.289	1.852	2.836	3.587	4.379	5.320	0.0008
Count	12	12	12	12	12	12	12	12	12	12	12



DATA SUMMARIES Continued

INSULATION RESISTANCE (IR):

	Pin to Pin		
	Mated	Unmated	Unmated
Minimum	**GMI/PCB**	**GMI**	**PCB**
Initial	45000	Not Tested	Not Tested
Thermal	45000	Not Tested	Not Tested
Humidity	45000	Not Tested	Not Tested

	Row to Row		
	Mated	Unmated	Unmated
Minimum	**GMI/PCB**	**GMI**	**PCB**
Initial	45000	Not Tested	Not Tested
Thermal	45000	Not Tested	Not Tested
Humidity	45000	Not Tested	Not Tested

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

Voltage Rating Summary	
Minimum	**GMI/PCB**
Break Down Voltage	800
Test Voltage	600
Working Voltage	200

Pin to Pin	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

Row to Row	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

DATA SUMMARIES Continued

LLCR Thermal Aging Group

1) A total of 192 points were measured.
2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.*
3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
   a. <= +5.0 mOhms:----------Stable
   b. +5.1 to +10.0 mOhms:----------Minor
   c. +10.1 to +15.0 mOhms: ----------Acceptable
   d. +15.1 to +50.0 mOhms: ----------Marginal
   e. +50.1 to +2000 mOhms ----------Unstable
   f. >+2000 mOhms:----------Open Failure

LLCR Measurement Summaries by Pin Type				
Date	10/21/2015	11/11/2015		
Room Temp (Deg C)	23	23		
Rel Humidity (%)	35	38		
Technician	Aaron McKim	Aaron McKim		
mOhm values	**Actual Initial**	**Delta Thermal**	**Delta**	**Delta**
	Pin Type 1: Signal			
Average	18.25	1.75		
St. Dev.	3.53	1.05		
Min	9.09	0.05		
Max	35.16	6.37		
Summary Count	192	192		
Total Count	192	192		

LLCR Delta Count by Category						
	Stable	**Minor**	**Acceptable**	**Marginal**	**Unstable**	**Open**
mOhms	**<=5**	**>5 & <=10**	**>10 & <=15**	**>15 & <=50**	**>50 & <=1000**	**>1000**
Thermal	**189**	**3**	**0**	**0**	**0**	**0**

DATA SUMMARIES Continued

LLCR Mating/Unmating Durability Group

1). A total of 192 points were measured.
2). EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.*
3). A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
4). The following guidelines are used to categorize the changes in LLCR as a result from stressing.
   a. <= +5.0 mOhms:----------Stable
   b. +5.1 to +10.0 mOhms: ----------Minor
   c. +10.1 to +15.0 mOhms: ----------Acceptable
   d. +15.1 to +50.0 mOhms: ----------Marginal
   e. +50.1 to +2000 mOhms ----------Unstable
   f. > +2000 mOhms:----------Open Failure

	LLCR Measurement Summaries by Pin Type			
Date	10/19/2015	10/26/2015	11/2/2015	11/12/2015
Room Temp (Deg C)	22	23	23	23
Rel Humidity (%)	43	41	40	39
Technician	Aaron McKim	Aaron McKim	Aaron McKim	Aaron McKim
mOhm values	**Actual Initial**	**Delta 100 Cycles**	**Delta Therm Shck**	**Delta Humidity**
	Pin Type 1: Signal			
Average	17.76	0.66	2.00	1.88
St. Dev.	2.24	1.00	1.32	1.54
Min	11.52	0.01	0.02	0.03
Max	24.73	7.88	9.69	14.09
Summary Count	192	192	192	192
Total Count	192	192	192	192

LLCR Delta Count by Category						
	Stable	**Minor**	**Acceptable**	**Marginal**	**Unstable**	**Open**
mOhms	**<=5**	**>5 & <=10**	**>10 & <=15**	**>15 & <=50**	**>50 & <=1000**	**>1000**
100 Cycles	**189**	**3**	**0**	**0**	**0**	**0**
Therm Shck	**186**	**6**	**0**	**0**	**0**	**0**
Humidity	**186**	**5**	**1**	**0**	**0**	**0**

DATA SUMMARIES Continued

LLCR Gas Tight Group

1) A total of 192 points were measured.
2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.*
3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
   a. <= +5.0 mOhms: ---------- Stable
   b. +5.1 to +10.0 mOhms: ---------- Minor
   c. +10.1 to +15.0 mOhms: ---------- Acceptable
   d. +15.1 to +50.0 mOhms: ---------- Marginal
   e. +50.1 to +2000 mOhms: ---------- Unstable
   f. >+2000 mOhms: ---------- Open Failure

	LLCR Measurement Summaries by Pin Type			
Date	8/19/2015	8/24/2015		
Room Temp (Deg C)	22	22		
Rel Humidity (%)	55	47		
Technician	Aaron McKim	Aaron McKim		
mOhm values	**Actual Initial**	**Delta Acid Vapor**	**Delta**	**Delta**
	Pin Type 1: Signal			
Average	17.18	0.92		
St. Dev.	3.11	0.80		
Min	6.28	0.00		
Max	24.76	3.86		
Summary Count	192	192		
Total Count	192	192		

LLCR Delta Count by Category						
	Stable	**Minor**	**Acceptable**	**Marginal**	**Unstable**	**Open**
mOhms	**<=5**	**>5 & <=10**	**>10 & <=15**	**>15 & <=50**	**>50 & <=1000**	**>1000**
Acid Vapor	**192**	**0**	**0**	**0**	**0**	**0**

DATA SUMMARIES Continued

LLCR Shock & Vibration Group

1) A total of 192 points were measured.
2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.*
3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
   a. <= +5.0 mOhms: ---------- Stable
   b. +5.1 to +10.0 mOhms: ---------- Minor
   c. +10.1 to +15.0 mOhms: ---------- Acceptable
   d. +15.1 to +50.0 mOhms: ---------- Marginal
   e. +50.1 to +2000 mOhms ---------- Unstable
   f. >+2000 mOhms: ---------- Open Failure

	LLCR Measurement Summaries by Pin Type			
Date	10/30/2015	11/9/2015		
Room Temp (Deg C)	23	22		
Rel Humidity (%)	42	33		
Technician	Aaron McKim	Aaron McKim		
mOhm values	**Actual Initial**	**Delta Shock-Vib**	**Delta**	**Delta**
	Pin Type 1: Signal			
Average	18.42	1.29		
St. Dev.	2.84	0.87		
Min	10.27	0.01		
Max	33.67	7.14		
Summary Count	192	192		
Total Count	192	192		

LLCR Delta Count by Category						
	Stable	**Minor**	**Acceptable**	**Marginal**	**Unstable**	**Open**
mOhms	**<=5**	**>5 & <=10**	**>10 & <=15**	**>15 & <=50**	**>50 & <=1000**	**>1000**
Shock-Vib	**191**	**1**	**0**	**0**	**0**	**0**

Nanosecond Event Detection:

Shock and Vibration Event Detection Summary	
Contacts tested	60
Test Condition	C, 100g's, 6ms, Half-Sine
Shock Events	0
Test Condition	V-B, 7.56 rms g
Vibration Events	0
Total Events	0

EQUIPMENT AND CALIBRATION SCHEDULES

Equipment #: THC-02
Description: Temperature/Humidity Chamber
Manufacturer: Thermotron
Model: SE-1000-6-6
Serial #: 31808
Accuracy: See Manual
… Last Cal: 02/16/2015, Next Cal: 02/16/2016

Equipment #: HPM-01
Description: Hipot Megommeter
Manufacturer: Hipotronics
Model: H306B-A
Serial #: M9905004
Accuracy: 2 % Full Scale Accuracy
… Last Cal: 05/24/2015, Next Cal: 08/24/2016

Equipment #: OV-05
Description: Forced Air Oven, 5 Cu. Ft., 120 V (Chamber Room)
Manufacturer: Sheldon Mfg.
Model: CE5F
Serial #: 02008008
Accuracy: +/- 5 deg. C
… Last Cal: 02/18/2015, Next Cal: 02/18/2016

Equipment #: TSC-01
Description: Vertical Thermal Shock Chamber
Manufacturer: Cincinnatti Sub Zero
Model: VTS-3-6-6-SC/AC
Serial #: 10-VT14993
Accuracy: See Manual
… Last Cal: 05/18/2015, Next Cal: 05/18/2016

Equipment #: MO-04
Description: Multimeter /Data Acquisition System
Manufacturer: Keithley
Model: 2700
Serial #: 0798688
Accuracy: See Manual
… Last Cal: 04/30/2015, Next Cal: 04/30/2016

EQUIPMENT AND CALIBRATION SCHEDULES

Equipment #: TCT-01
Description: Test Stand
Manufacturer: Chatillon
Model: TCD-1000
Serial #: 05 23 00 02
Accuracy: Speed Accuracy: +/-5% of max speed; Displacement: +/-.5% or +/-.005, whichever is greater.
… Last Cal: 08/24/2015, Next Cal: 08/24/2016

Equipment #: PS-01
Description: Power Supply
Manufacturer: Agilent
Model: AT-6032A
Serial #: MY41001186
Accuracy: Last Cal: 06/12/2015, Next Cal: 046/12/2016

Equipment #: MO-03
Description: Multimeter /Data Acquisition System
Manufacturer: Keithley
Model: 2700
Serial #: 0791975
Accuracy: See Manual
… Last Cal: 05/19/2015, Next Cal: 05/19/2016

Equipment #: SVC-01
Description: Shock & Vibration Table
Manufacturer: Data Physics
Model: LE-DSA-10-20K
Serial #: 10037
Accuracy: See Manual
… Last Cal: 11/31/2015, Next Cal: 11/31/2016

Equipment #: ACLM-01
Description: Accelerometer
Manufacturer: PCB Piezotronics
Model: 352C03
Serial #: 115819
Accuracy: See Manual
… Last Cal: 07/09/2015, Next Cal: 07/09/2016

Equipment #: ED-03
Description: Event Detector
Manufacturer: Analysis Tech
Model: 32EHD
Serial #: 1100604
Accuracy: See Manual
… Last Cal: 06/04/2015, Next Cal: 06/04/2016